

## P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY			
$V_{DS}$ (V)	$R_{DS(on)}$ ( $\Omega$ )	$I_D$ (A) <sup>a</sup>	$Q_g$ (Typ.)
- 30	0.049 at $V_{GS} = - 10$ V	- 4.8	5.1 nC
	0.054 at $V_{GS} = - 4.5$ V	- 4.1	

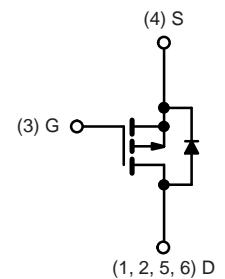
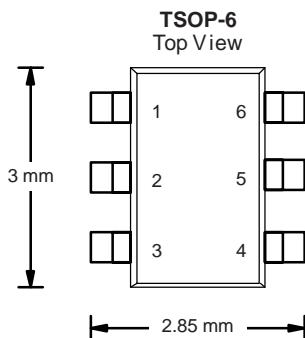
### FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET



### APPLICATIONS

- Load Switch



P-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	- 30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current ( $T_J = 150$ °C)	$I_D$	- 4.8	A
		- 4.1	
		- 4.0 <sup>b, c</sup>	
		- 3.5 <sup>b, c</sup>	
Pulsed Drain Current	$I_{DM}$	- 20	A
Continuous Source-Drain Diode Current	$I_S$	- 2.5	
		- 1.67 <sup>b, c</sup>	
Maximum Power Dissipation	$P_D$	3.0	W
		2.0	
		2.0 <sup>b, c</sup>	
		1.3 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to 150	°C

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b, d</sup>	$t \leq 5$ s	$R_{thJA}$	55	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	34	

Notes:

- a. Based on  $T_C = 25$  °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c.  $t = 5$  s.
- d. Maximum under Steady State conditions is 110 °C/W.

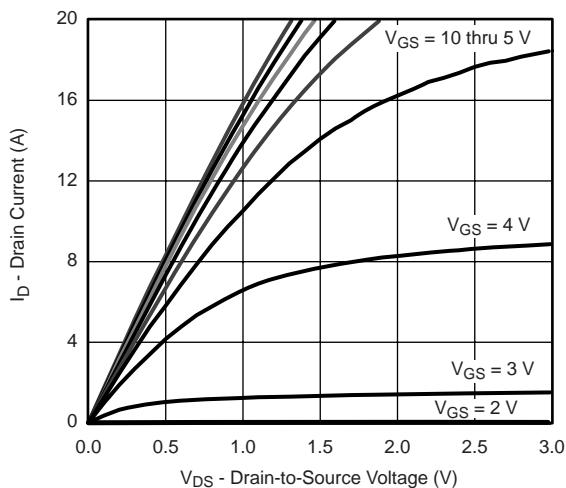
**SPECIFICATIONS**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}$ , $I_D = -250 \mu\text{A}$	-30			V
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = -250 \mu\text{A}$		-31		mV/°C
$V_{GS(\text{th})}$ Temperature Coefficient	$\Delta V_{GS(\text{th})}/T_J$			4.5		
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$ , $I_D = -250 \mu\text{A}$	-0.5		-2.0	V
Gate-Source Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}$ , $V_{GS} = \pm 20 \text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -30 \text{ V}$ , $V_{GS} = 0 \text{ V}$			-1	μA
		$V_{DS} = -30 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_J = 55^\circ\text{C}$			-10	
On-State Drain Current <sup>a</sup>	$I_{D(\text{on})}$	$V_{DS} \leq -5 \text{ V}$ , $V_{GS} = -10 \text{ V}$	-20			A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(\text{on})}$	$V_{GS} = -10 \text{ V}$ , $I_D = -4.1 \text{ A}$		0.049		Ω
		$V_{GS} = -4.5 \text{ V}$ , $I_D = -1.0 \text{ A}$		0.054		
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = -15 \text{ V}$ , $I_D = -4.1 \text{ A}$		8		S
<b>Dynamic<sup>b</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = -15 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1 \text{ MHz}$		450		pF
Output Capacitance	$C_{oss}$			80		
Reverse Transfer Capacitance	$C_{rss}$			63		
Total Gate Charge	$Q_g$	$V_{DS} = -15 \text{ V}$ , $V_{GS} = -10 \text{ V}$ , $I_D = -4.1 \text{ A}$		10	15	nC
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -15 \text{ V}$ , $V_{GS} = -4.5 \text{ V}$ , $I_D = -4.1 \text{ A}$		5.1	8	
Gate-Drain Charge	$Q_{gd}$			1.8		
Gate Resistance	$R_g$			2.5		
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = -15 \text{ V}$ , $R_L = 4.6 \Omega$ $I_D \equiv -3.3 \text{ A}$ , $V_{GEN} = -4.5 \text{ V}$ , $R_g = 1 \Omega$		7		Ω
Rise Time	$t_r$			40	60	ns
Turn-Off Delay Time	$t_{d(\text{off})}$			80	120	
Fall Time	$t_f$			20	30	
Turn-On Delay Time	$t_{d(\text{on})}$			12	20	
Rise Time	$t_r$			5	10	
Turn-Off Delay Time	$t_{d(\text{off})}$			13	20	
Fall Time	$t_f$			20	30	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Source-Drain Diode Current	$I_S$	$T_C = 25^\circ\text{C}$			-2.5	A
Pulse Diode Forward Current <sup>a</sup>	$I_{SM}$				-20	
Body Diode Voltage	$V_{SD}$	$I_S = -3.3 \text{ A}$		-0.8	-1.2	V
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = -3.3 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$ , $T_J = 25^\circ\text{C}$		20	30	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$			20	30	nC
Reverse Recovery Fall Time	$t_a$			14		ns
Reverse Recovery Rise Time	$t_b$			6		

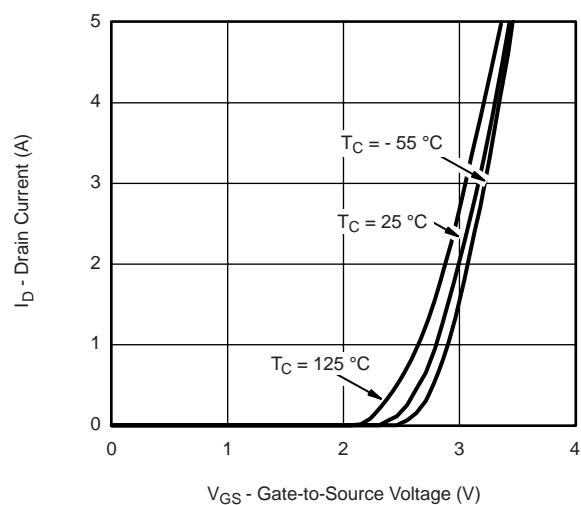
Notes:

a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$   
b. Guaranteed by design, not subject to production testing.

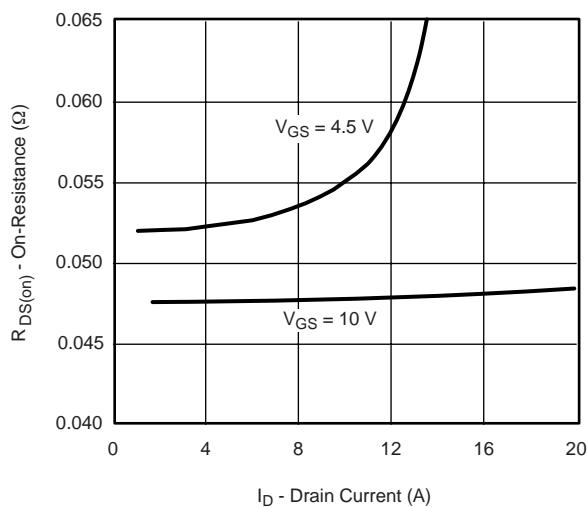
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


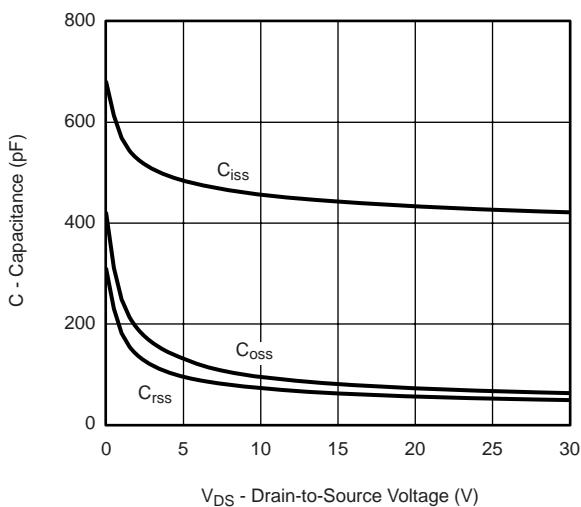
Output Characteristics



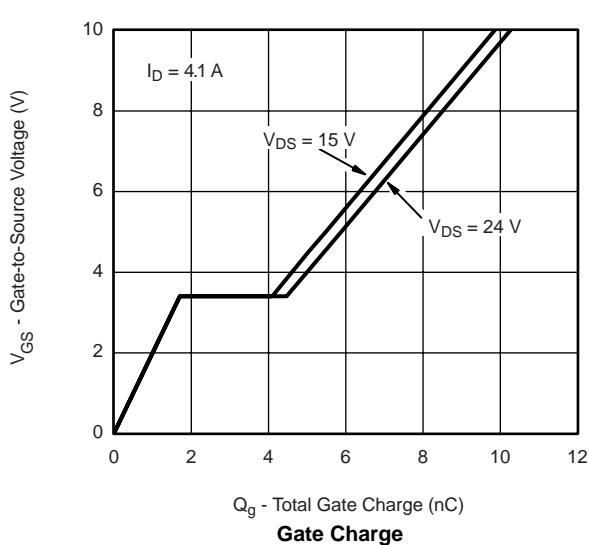
Transfer Characteristics



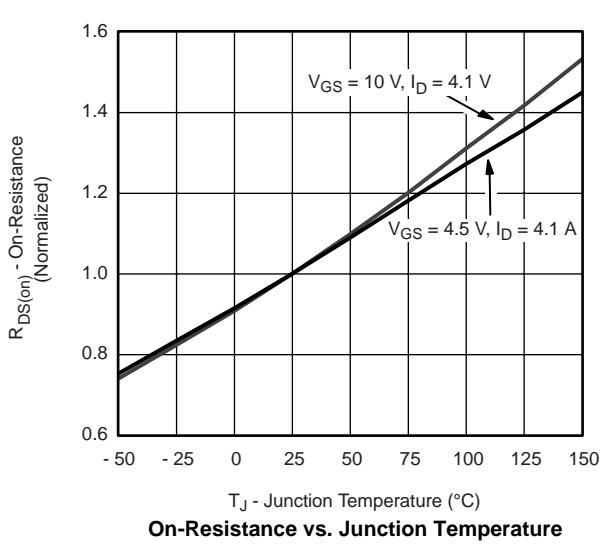
On-Resistance vs. Drain Current and Gate Voltage



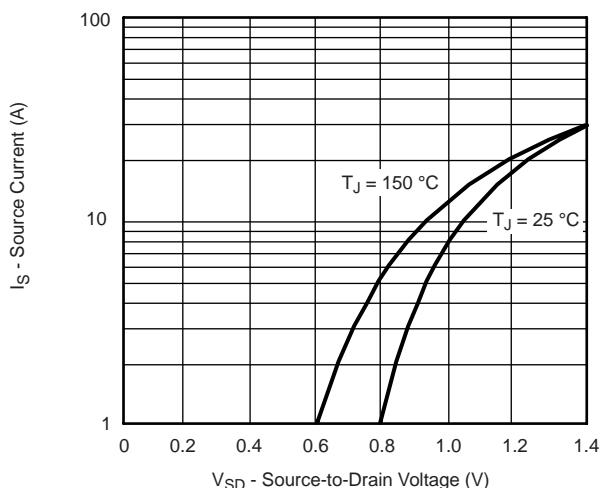
Capacitance



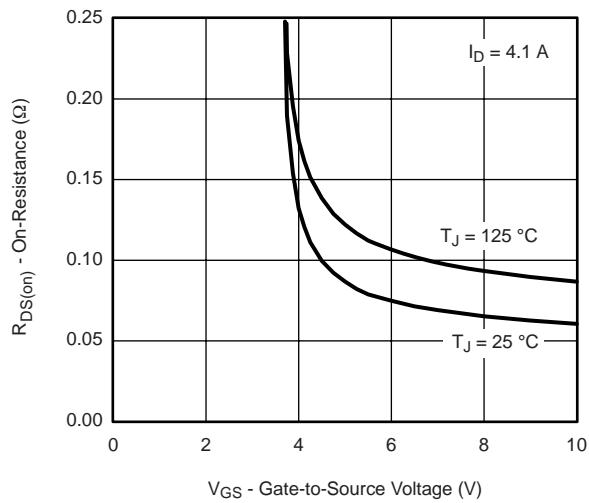
Gate Charge



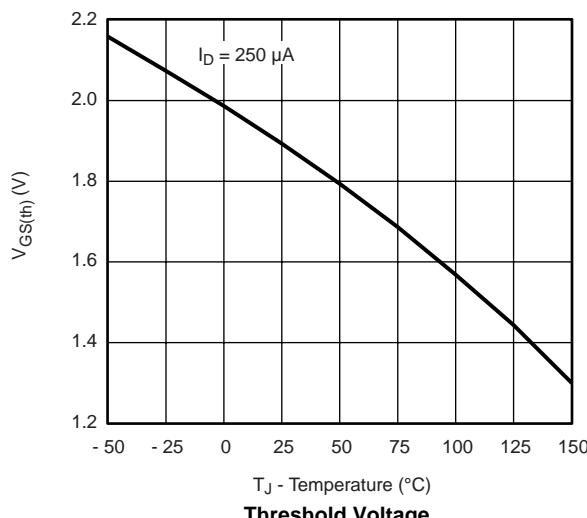
On-Resistance vs. Junction Temperature

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


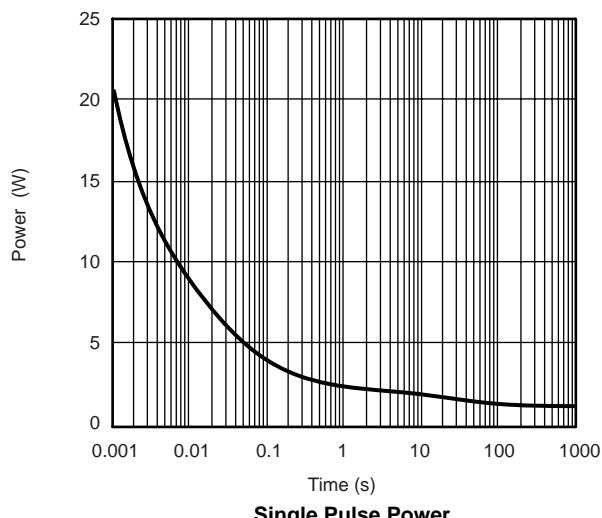
Source-Drain Diode Forward Voltage



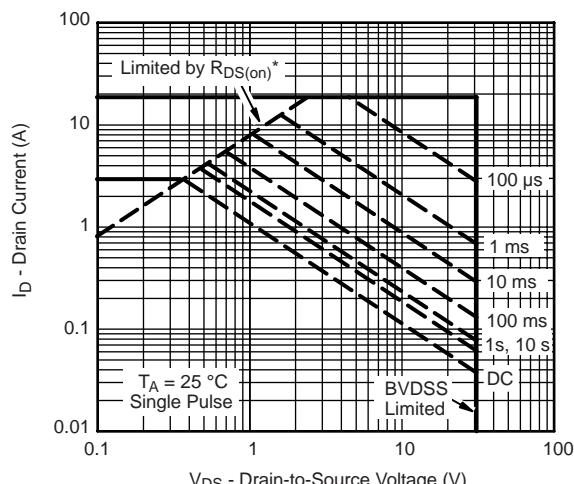
On-Resistance vs. Gate-to-Source Voltage



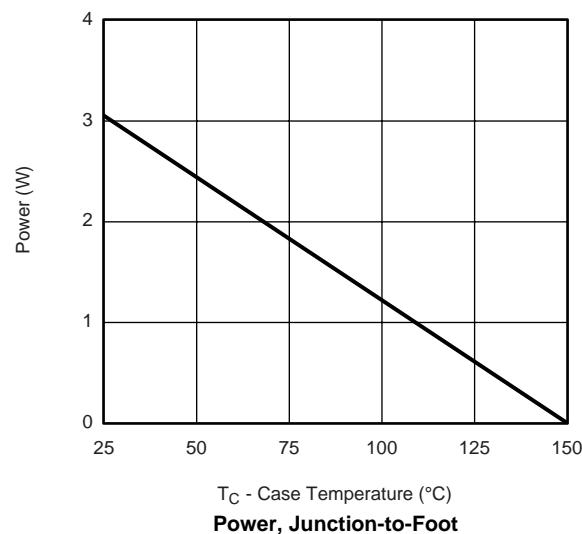
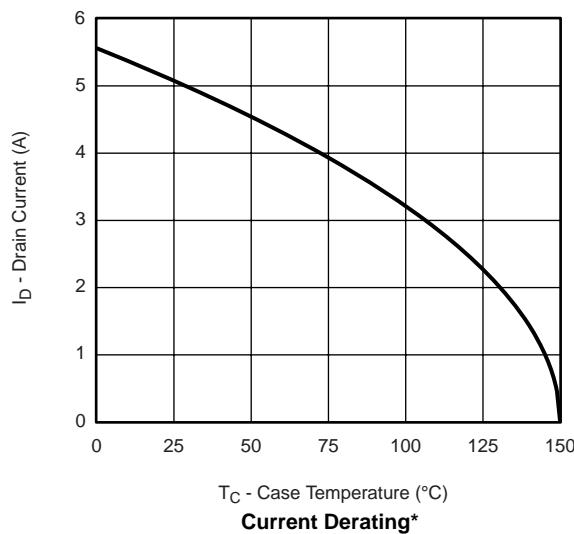
Threshold Voltage



Single Pulse Power

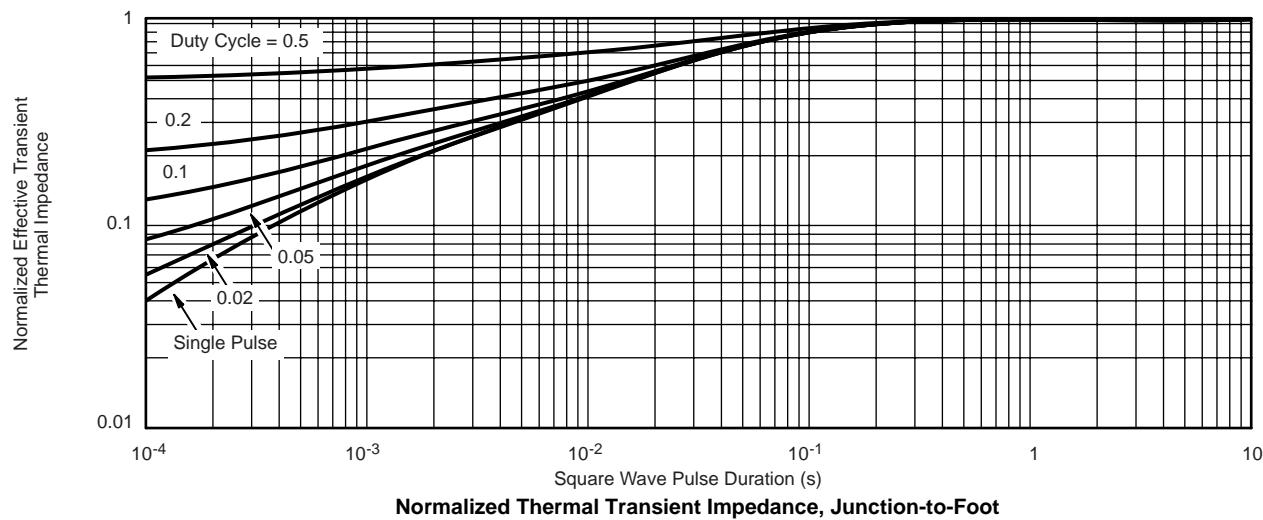
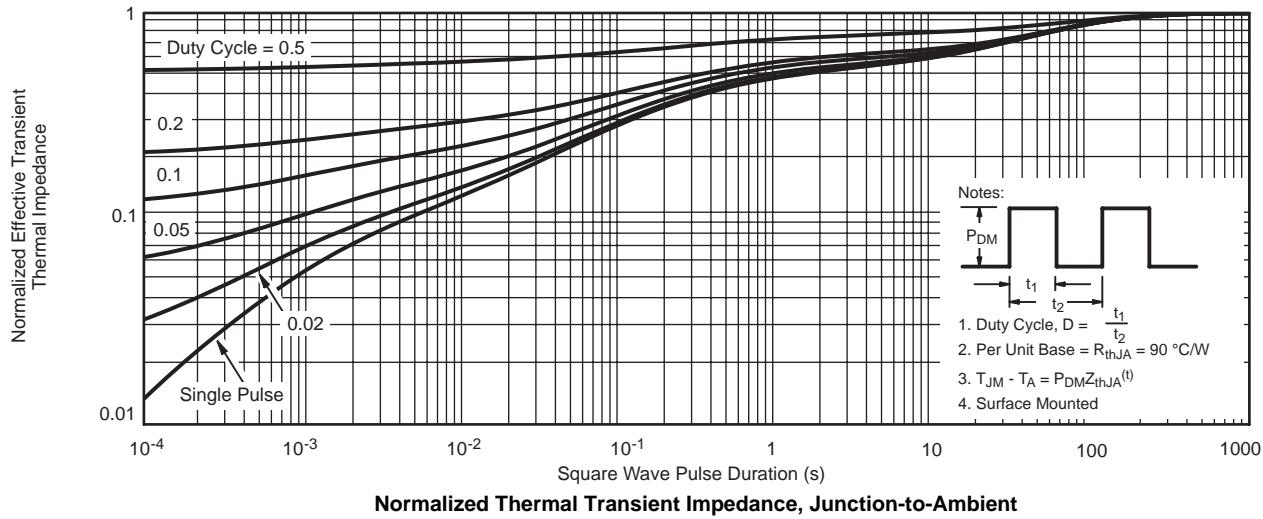
\*  $V_{GS} > \text{minimum } V_{GS}$  at which  $R_{DS(\text{on})}$  is specified

Safe Operating Area

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

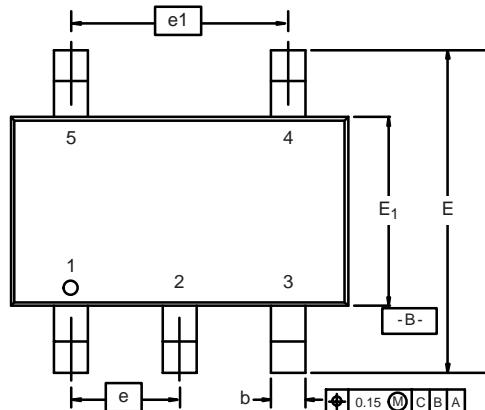
\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

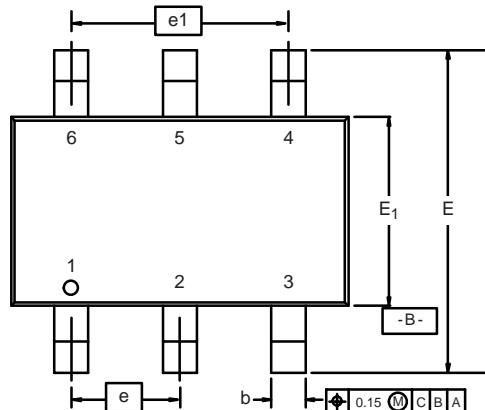


## TSOP: 5/6-LEAD

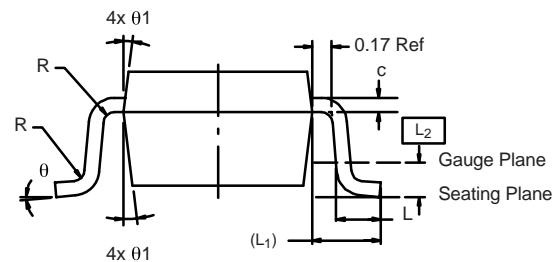
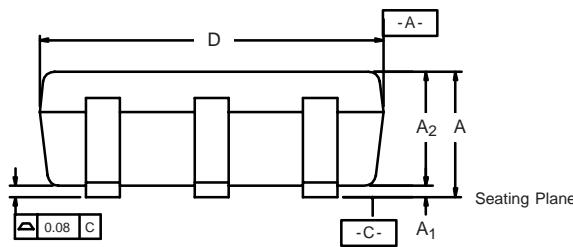
JEDEC Part Number: MO-193C



5-LEAD TSOP



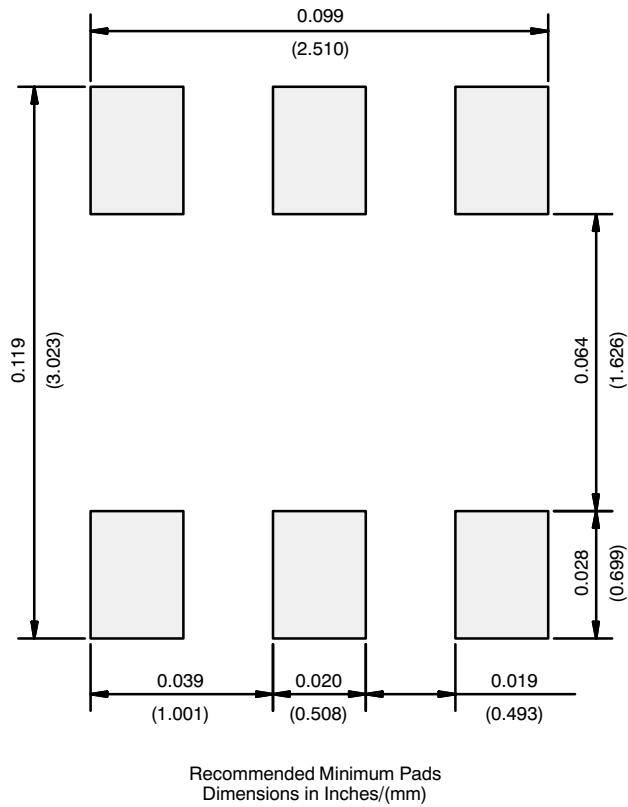
6-LEAD TSOP



Dim	MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max
<b>A</b>	0.91	-	1.10	0.036	-	0.043
<b>A<sub>1</sub></b>	0.01	-	0.10	0.0004	-	0.004
<b>A<sub>2</sub></b>	0.90	-	1.00	0.035	0.038	0.039
<b>b</b>	0.30	0.32	0.45	0.012	0.013	0.018
<b>c</b>	0.10	0.15	0.20	0.004	0.006	0.008
<b>D</b>	2.95	3.05	3.10	0.116	0.120	0.122
<b>E</b>	2.70	2.85	2.98	0.106	0.112	0.117
<b>E<sub>1</sub></b>	1.55	1.65	1.70	0.061	0.065	0.067
<b>e</b>	0.95 BSC			0.0374 BSC		
<b>e<sub>1</sub></b>	1.80	1.90	2.00	0.071	0.075	0.079
<b>L</b>	0.32	-	0.50	0.012	-	0.020
<b>L<sub>1</sub></b>	0.60 Ref			0.024 Ref		
<b>L<sub>2</sub></b>	0.25 BSC			0.010 BSC		
<b>R</b>	0.10	-	-	0.004	-	-
<b>θ</b>	0°	4°	8°	0°	4°	8°
<b>θ<sub>1</sub></b>	7° Nom			7° Nom		

ECN: C-06593-Rev. I, 18-Dec-06  
 DWG: 5540

## RECOMMENDED MINIMUM PADS FOR TSOP-6



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